

1.6x0.6mm RIGHT ANGLE SMD CHIP LED **LAMP**



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE **SENSITIVE**

DEVICES

Part Number: APA1606ZGC/E Green

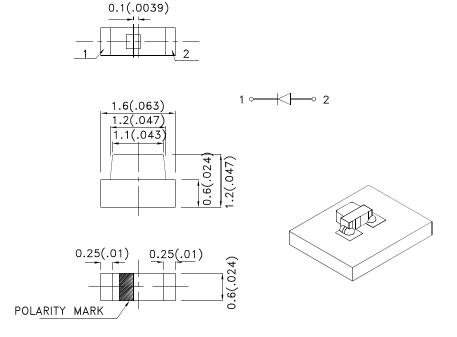
Features

- 1.6x1.2x0.6mm right angle SMD LED, 0.6mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package :2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Descriptions

- The Green source color devices are made with InGaN Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions



Notes:

- All dimensions are in millimeters (inches).
 Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

| Part No. | Emitting Color (Material) | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|--------------|---------------------------|-------------|------------------------|------|----------------------|
| | | 2. | Min. | Тур. | 201/2 |
| APA1606ZGC/E | Green (InGaN) | Water Clear | 400 | 600 | 110° |

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous Flux: +/-15%.
 3. Luminous intensity value is traceable to CIE127-2007 standards.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Emitting Color | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|----------------|------|------|-------|-----------------|
| λpeak | Peak Wavelength | Green | 520 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Green | 525 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Green | 35 | | nm | IF=20mA |
| С | Capacitance | Green | 100 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Green | 3.2 | 4 | V | IF=20mA |
| lr | Reverse Current | Green | | 50 | uA | VR=5V |

Notes:

- 1. Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

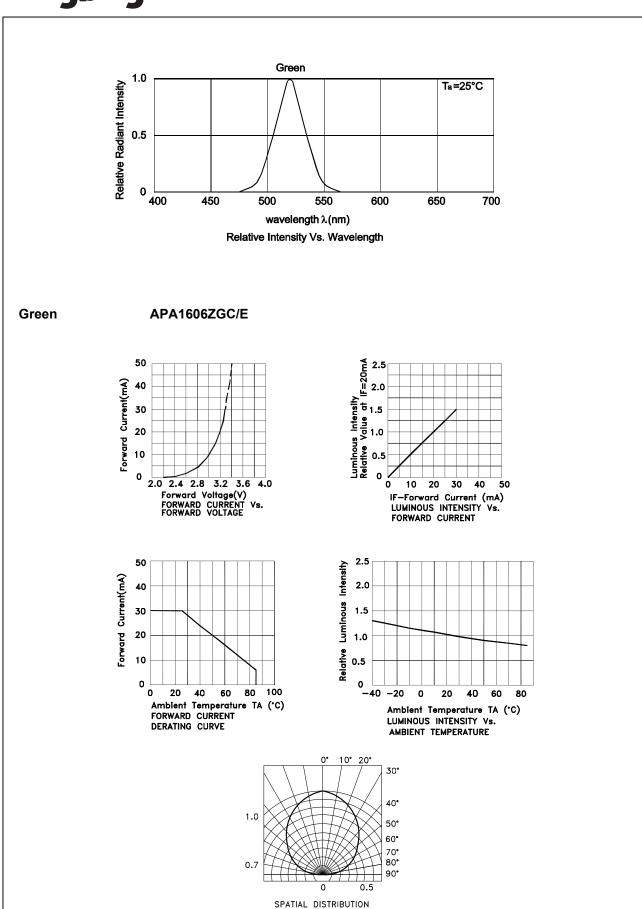
Absolute Maximum Ratings at TA=25°C

| Parameter | Values | Units | |
|---|---------------------|-------|--|
| Power dissipation | 120 | mW | |
| DC Forward Current | 30 | mA | |
| Peak Forward Current [1] | 100 | mA | |
| Electrostatic Discharge Threshold (HBM) | 450 | V | |
| Reverse Voltage | 5 | V | |
| Operating Temperature | -40°C To +85°C | | |
| Storage Temperature | ture -40°C To +85°C | | |

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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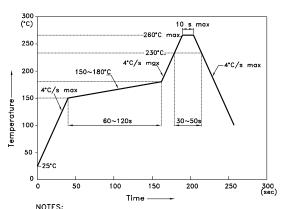
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

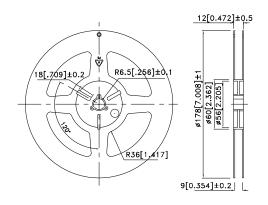
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

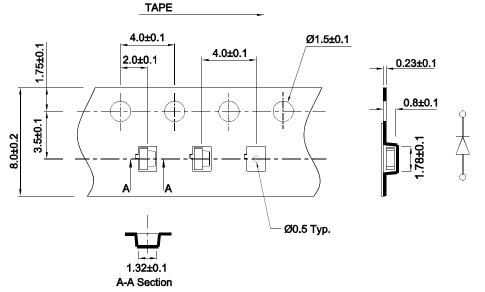
0.9 0.9

1.6

Tape Dimensions (Units: mm)

Reel Dimension





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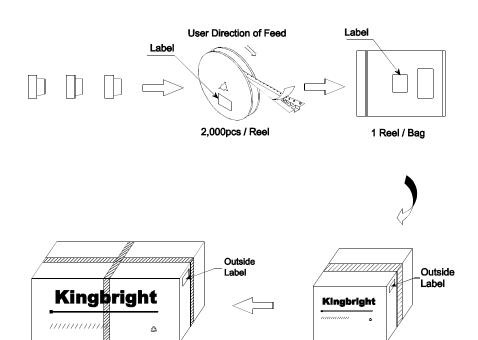
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PACKING & LABEL SPECIFICATIONS

APA1606ZGC/E

30K / 55# Box





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